

Form PTO 1449 U.S. Department of Commerce Patent and Trademark Office Information Disclosure Statement by Applicant	ATTY. DOCKET NUMBER NITT.0158	SERIAL NUMBER To be Assigned 10/700,519
	APPLICANT Ichimura et al.	
	FILING DATE Concurrently Herewith	GROUP 2627

U.S. Patent Documents

Examiner Initial	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE

Foreign Patent Documents

Examiner Initial	DOCUMENT NUMBER	FILING DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION	
						YES	NO
DD	2001-156357	9/1/2000	Japan			Abstract	X
DD	11-135857	10/30/97	Japan			Abstract	X

Other Documents (Including Author, Title, Date Pertinent Pages, Etc.)

DD	J.Z. Sun, D.W. Abraham, K. Roche and S.S.P. Parkin, "Temperature and Bias Dependence of Magnetoresistance in Doped Manganite Thin Film Trilayer Junctions", Applied Physics Letters, Volume 73, Number 7, August 17, 1998, pp. 1008-1010
DD	Jagadeesh S. Moodera and Lisa R. Kinder, "Ferromagnetic-Insulator-Ferromagnetic Tunneling: Spin-Dependent Tunneling and Large Magnetoresistance in Trilayer Junctions (Invited)", J. Appl. Phys. 79 (8), April 15, 1996, pp. 4724-4729
DD	J.S. Moodera, Lisa R. Kinder, Terrilyn M. Wong and R. Meservy, "Large Magnetoresistance at Room Temperature in Ferromagnetic Thin Film Tunnel Junctions", Physical Review Letters, Volume 74, Number 16, April 17, 1995, pp. 3273-3276
DD	J.A. Katine, F.J. Albert, R.A. Buhrman, E.B. Myers and D.C. Ralph, "Current-Driven Magnetization Reversal and Spin-Wave Excitations in Co/Cu/Co Pillars", Physical Review Letters, Volume 84, Number 14, April 3, 2000, pp. 3149-3152
DD	J. Grollier, V. Cros, A. Hamzic, J.M. George, H. Jaffrès, A. Fert, G. Faini, J. Ben Youssef and H. Legall, "Spin-Polarized Current Induced Switching in Co/Cu/Co Pillars", Applied Physics Letters, Volume 78, Number 23, June 4, 2001, pp. 3663-3665
EXAMINER	/David Davis/
DATE CONSIDERED	12/11/2006
EXAMINER: Initial if citation is considered, whether or not citation is in conformance with MPEP 609; draw a line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant	